



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Attn: OIPE

Tomohiko TAKEDA et al.

Application No.: 10/549,279

Docket No.: 125328

Filed: October 19, 2005

For: SUBSTRATE PROCESSING APPARATUS AND SUBSTRATE PROCESSING

METHOD

REQUEST FOR CORRECTION OF PALM RECORDS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records. A Supplemental Application Data Sheet is attached.

Respectfully submitted,

Sames A. Oliff

Registration No. 27,075

David R. Kemeny

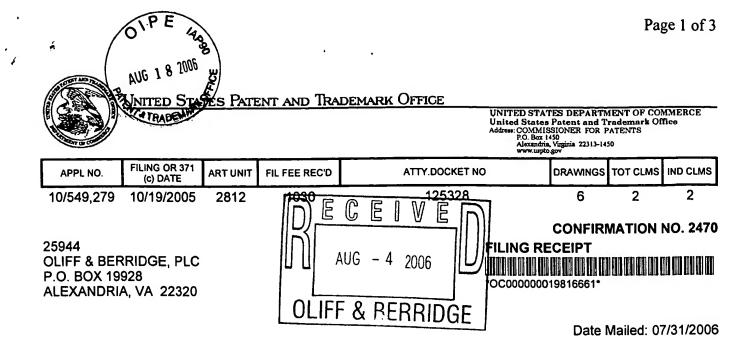
Registration No. 57,241

JAO:DRK/crh

Date: August 18, 2006

OLIFF & BERRIDGE, PLC

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Applicant(s)

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Assignment For Published Patent Application

HITACHI KOKUSAI ELECTRIC INC., Nakano-ku, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 25944.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/11162 08/04/2004

Foreign Applications

JAPAN 2003-289223 08/07/2003

If Required, Foreign Filing License Granted: 07/28/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US10/549,279

Projected Publication Date: 11/09/2006. . . .

Non-Publication Request: No

Early Publication Request: No

Title "

.1)

Substrate processing apparatus and sustrate processing method

Preliminary Class

438

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ATTORNEYS AT LAW

Supplemental Application Data Sheet



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Correspondence Information

Correspondence Customer Number:: 25944

Application Information

Application Type:: National Phase

Subject Matter:: Utility
CD-ROM or CD-R:: None

Title:: SUBSTRATE PROCESSING APPARATUS

AND SUBSTRATE PROCESSING

METHOD

Attorney Docket Number:: 125328

Total Drawing Sheets:: 6

Small Entity:: No

Representative Information

Attorneys associated with Customer No. 25944.

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP04/11162	8/4/04
Foreign Priority Information			I
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-289223	8/7/03	Yes
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